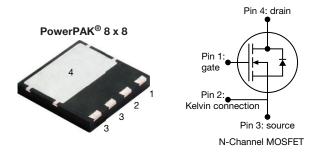
SiHH070N60EF

Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



www.vishay.com

PRODUCT SUMMARY					
V_{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.061				
Q _g max. (nC)	75				
Q _{gs} (nC)	20				
Q _{gd} (nC)	17				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION					
Package	PowerPAK 8 x 8				
Lead (Pb)-free and halogen-free	SiHH070N60EF-T1GE3				

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	V	
Gate-source voltage			V _{GS}	± 30	v	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C	- I _D	36		
	VGS AL TO V	T _C = 100 °C		23	A	
Pulsed drain current ^a			I _{DM}	93		
Linear derating factor				1.6	W/°C	
Single pulse avalanche energy ^b			E _{AS}	226	mJ	
Maximum power dissipation			PD	202	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope T _J = 125 °C			dv/dt	100	V/ns	
Reverse diode dv/dt ^d			uv/dl	50	v/ns	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4 A
- c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 900 A/µs, starting T_J = 25 °C

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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT	
Maximum junction-to-ambient	R _{thJA}	38		50				
Maximum junction-to-case (drain)	R _{thJC}	0.48 0.62				°C/W		
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C_{,}$	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNI
Static	•	1				•		
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	l _D = 20 mA	-	0.51	-	V/°0
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	V_{GS} , $I_D = 2$	250 μA	3	-	5	V
		,	$V_{\rm GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{\rm GS} = \pm 30$	V	-	-	± 1	μA
Zeve acto velto no ducio como et		V _{DS} =	480 V, V _G	_S = 0 V	-	-	1	μA
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	, V _{GS} = 0 V	, T _J = 125 °C	-	-	2	mA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	١ _D	₀ = 15 A	-	0.061	0.071	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 20 V, I _D =	: 15 A	-	10.5	-	S
Dynamic	-	•				•	•	
Input capacitance	C _{iss}		$V_{GS} = 0 V,$		-	2647	-	
Output capacitance	C _{oss}	, 	$V_{DS} = 100 V,$		-	122	-	1
Reverse transfer capacitance	C _{rss}	f = 1 MHz		-	6	-		
Effective output capacitance, energy related ^a	C _{o(er)}			-	90	-	pF	
Effective output capacitance, time related ^b	C _{o(tr)}	$v_{\rm DS} = 0$	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	560	-	1
Total gate charge	Qg			-	50	75	1	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 15 A, V _{DS} = 480 V		-	20	-	nC
Gate-drain charge	Q _{gd}				-	17	-	1
Turn-on delay time	t _{d(on)}				-	36	72	
Rise time	t _r	- V _{DD} =	= 480 V, I _D =	= 15 A,	-	79	119	- ns
Turn-off delay time	t _{d(off)}	V _{GS} =	= 10 V, R _g =	9.1 Ω	-	55	83	
Fall time	t _f				-	38	76	1
Gate input resistance	R _g		f = 1 MHz		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characterist								
Continuous source-drain diode current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	36		
Pulsed diode forward current	I _{SM}			-	-	93	A	
Diode forward voltage	V _{SD}	T _J = 25 °C	T _J = 25 °C, I _S = 15 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}				-	136	272	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 15 \text{ A},$		-	0.9	1.8	μ	
Reverse recovery current	I _{RRM}		di/dt = 100 A/µs, V _R = 400 V		-	12	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

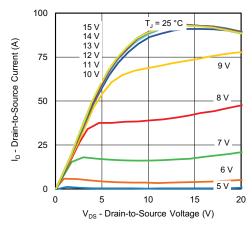


Fig. 1 - Typical Output Characteristics

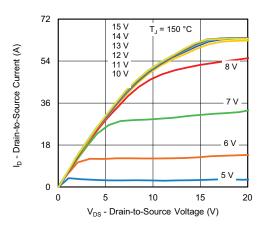


Fig. 2 - Typical Output Characteristics

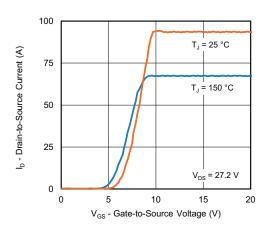


Fig. 3 - Typical Transfer Characteristics

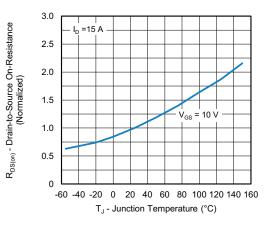


Fig. 4 - Normalized On-Resistance vs. Temperature

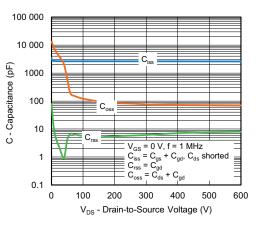


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

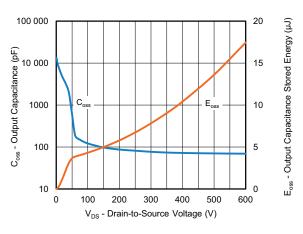


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

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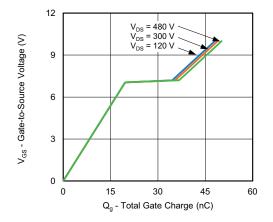


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

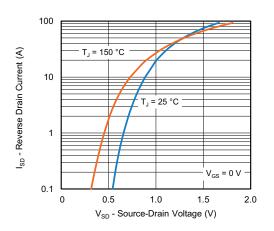


Fig. 8 - Typical Source-Drain Diode Forward Voltage

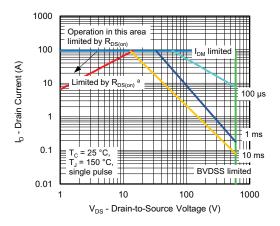


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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4



75

50

40

35

30

25

20 15

10 5

0

Drain Current (A)

<u>_</u>

Fig. 10 - Maximum Drain Current vs. Case Temperature

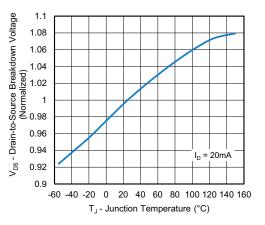
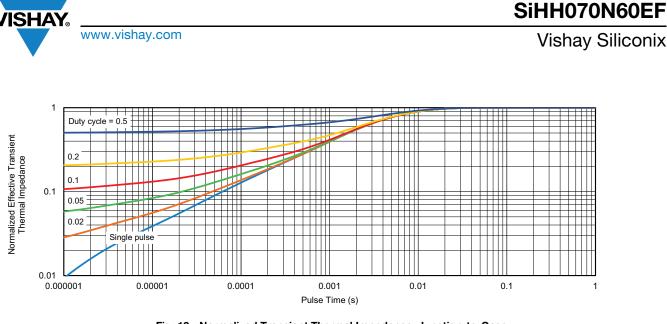


Fig. 11 - Temperature vs. Drain-to-Source Voltage





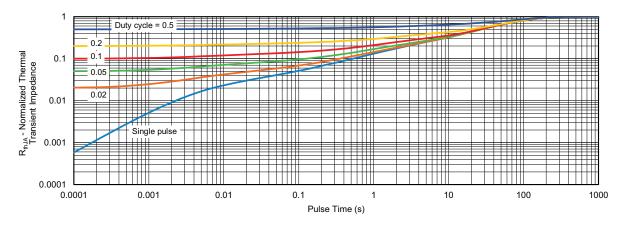


Fig. 13 - Normalized Transient Thermal Impedance, Junction-to-Ambient

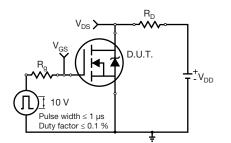


Fig. 14 - Switching Time Test Circuit

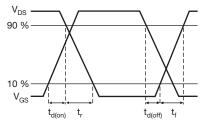


Fig. 15 - Switching Time Waveforms

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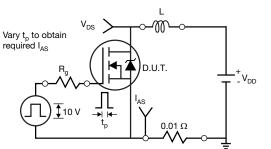
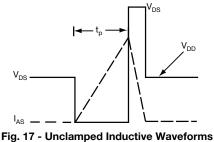


Fig. 16 - Unclamped Inductive Test Circuit



- Onclamped inductive wavelorms

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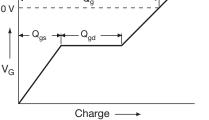


Fig. 18 - Basic Gate Charge Waveform

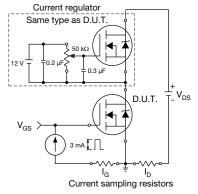


Fig. 19 - Gate Charge Test Circuit



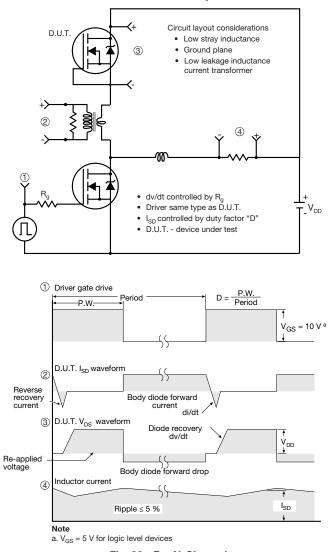


Fig. 20 - For N-Channel

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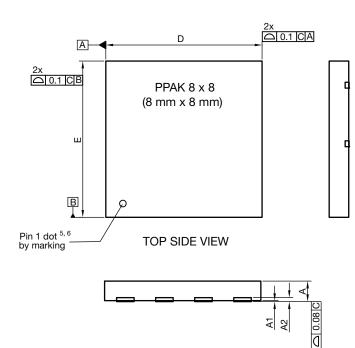
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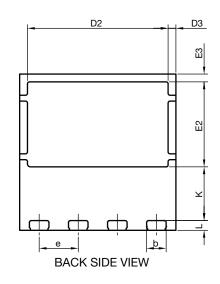
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Vishay Siliconix

PowerPAK[®] 8 x 8 Case Outline





DIM.	MILLIMETERS			INCHES			
Divi.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2		020 ref.			0.008 ref.		
b	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3	0.40 BSC			0.016 BSC			
е	2.00 BSC			0.079 BSC			
E	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3	0.40 BSC		0.016 BSC				
К	2.75 BSC						
L	0.45	0.50	0.55	0.018	0.020	0.022	
N ⁽³⁾	8			8			

Notes

 $^{\left(1\right) }$ Use millimeters as the primary measurement

⁽²⁾ Dimensioning and tolerances conform to ASME Y14.5 M - 1994

⁽³⁾ N is the number of terminals

⁽⁴⁾ The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

⁽⁵⁾ Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

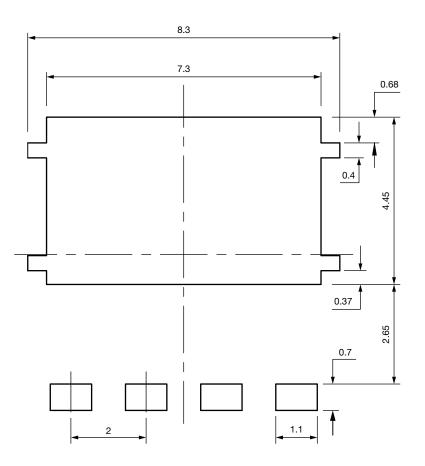
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Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters



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